

Features

- Uses PingWei advanced PerfectMOS2 technology
- Extremely low on-resistance $R_{DS(on)}$
- Excellent $Q_g \times R_{DS(on)}$ product(FOM)
- Qualified according to AEC-Q101 criteria

Benefits

- High robustness and reliability
- Increases maximum current capability
- Low power loss, high power density

Applications

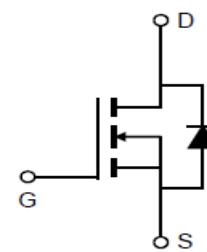
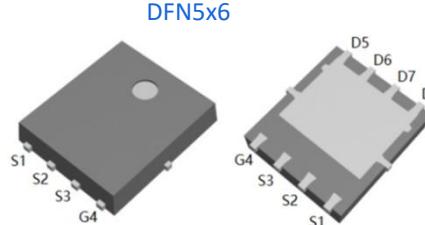
- Automotive applications
- Battery management
- Motor Drivers



100% DVDS Tested
100% AvalancheTested

Product Summary

V_{DS}	40V
$R_{DS(on)}$ @10V typ	1.1mΩ
I_D (Silicon limit)	252A



Package Marking and Ordering Information

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
PWC013N04ESQ	C013N04ESQ	DFN5x6	Tape&Reel	13 inches	12mm	5000pcs

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	40	V
Continuous drain current $T_C = 25^\circ\text{C}$ (Silicon limit) $T_C = 100^\circ\text{C}$ (Silicon limit) $T_C = 25^\circ\text{C}$ (Package limit) $T_a = 25^\circ\text{C}$ (Note1)	I_D	252 178 120 34	A
Pulsed drain current ($T_C = 25^\circ\text{C}$)	$I_{D\text{ pulse}}$	480	A
Avalanche energy, single pulse ($L=0.3\text{mH}$, $V_{ds}=32\text{V}$)	E_{AS}	240	mJ
Gate-Source voltage	V_{GS}	± 20	V
Power dissipation $T_C = 25^\circ\text{C}$ $T_a = 25^\circ\text{C}$	P_{tot}	142 2.6	W
Operating junction and storage temperature	T_j , T_{stg}	-55...+175	°C
Reflow soldering temperature (10s)	T_{sold}	260	°C

Thermal Resistance

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Thermal resistance, junction – case.	R _{thJC}	-	-	1.1	°C/W	-
Thermal resistance, junction - ambient	R _{thJA}	-	-	59	°C/W	Note 1

Electrical Characteristic (at T_j = 25 °C, unless otherwise specified)

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		

Static Characteristic

Drain-source breakdown voltage	BV _{DSS}	40	-	-	V	V _{GS} =0V, I _D =250uA
Gate threshold voltage	V _{GS(th)}	2.0	-	4.0	V	V _{DS} =V _{GS} , I _D =250uA
Zero gate voltage drain current	I _{DSS}	-	0.05	1	μA	V _{DS} =40V, V _{GS} =0V T _j =25°C T _j =150°C
Gate-source leakage current	I _{GSS}	-	±10	±100	nA	V _{GS} =±20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	1.1	1.3	mΩ	V _{GS} =10V, I _D =50A
Transconductance	g _{fs}	-	109	-	S	V _{DS} =5V, I _D =50A

Dynamic Characteristic

Input Capacitance	C _{iss}	-	4784	-	pF	V _{GS} =0V, V _{DS} =20V, f=250KHz
Output Capacitance	C _{oss}	-	1628	-		
Reverse Transfer Capacitance	C _{rss}	-	52	-		
Gate Total Charge	Q _G	-	68	-	nC	V _{DS} =20V, I _D =50A , V _{GS} =10V
Gate-Source charge	Q _{gs}	-	29	-		
Gate-Drain charge	Q _{gd}	-	8	-		
Turn-on delay time	t _{d(on)}	-	17	-		
Rise time	t _r	-	43	-		
Turn-off delay time	t _{d(off)}	-	46	-	ns	V _{GS} =10V, V _{DD} =20V, R _G =1.6Ω, I _D =50A
Fall time	t _f	-	22	-		
Gate resistance	R _G	-	2.1	-	Ω	V _{GS} =0V, V _{DS} =0V, f=1MHz

Body Diode Characteristic

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Body Diode Forward Voltage	V_{SD}	-	-	1.2	V	$V_{GS}=0V, I_{SD}=50A$
Body Diode Continuous Forward Current	I_S	-	-	120	A	$T_C = 25^\circ C$
Body Diode Pulsed Current	I_S pulse	-	-	480	A	$T_C = 25^\circ C$
Body Diode Reverse Recovery Time	t_{rr}	-	49	-	ns	$V_R=20V, I_F=50A,$ $dI/dt=100A/\mu s$
Body Diode Reverse Recovery Charge	Q_{rr}	-	26	-	nC	

Note1. 1 inch², 2oz single copper FR-4 PCB.

Typical Performance Characteristics

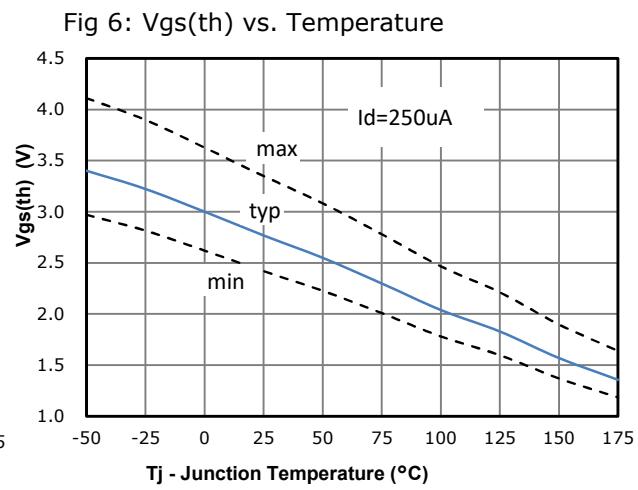
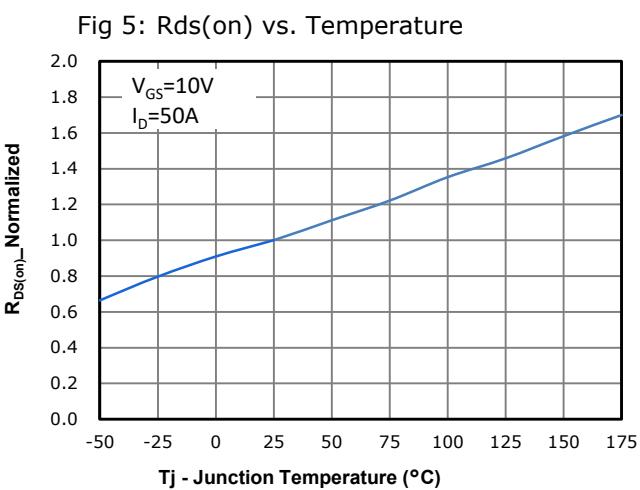
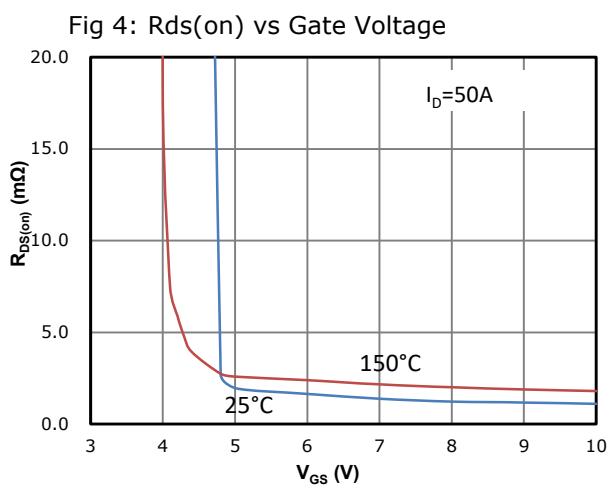
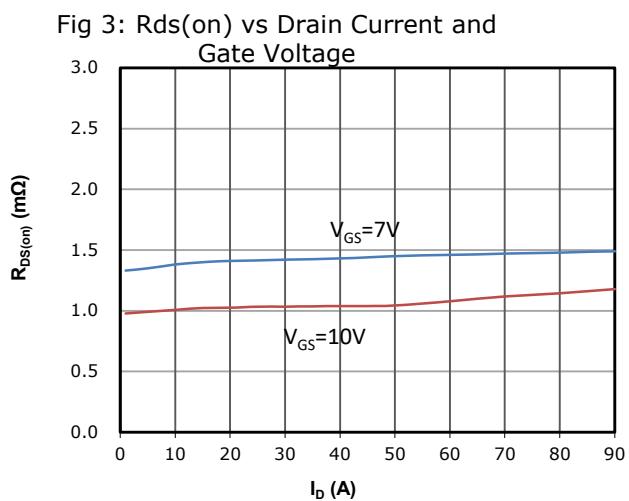
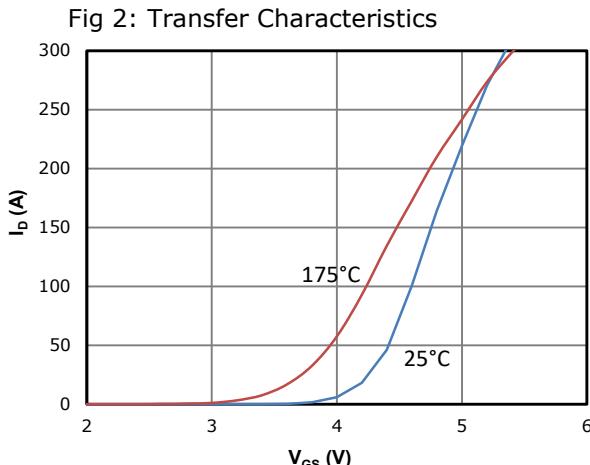
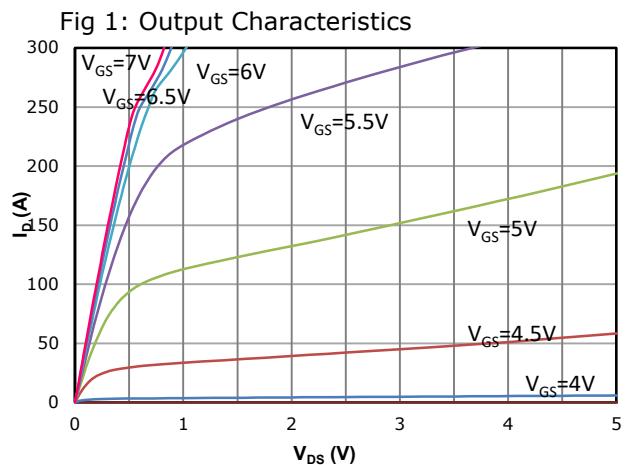


Fig 7: BV_{dss} vs. Temperature

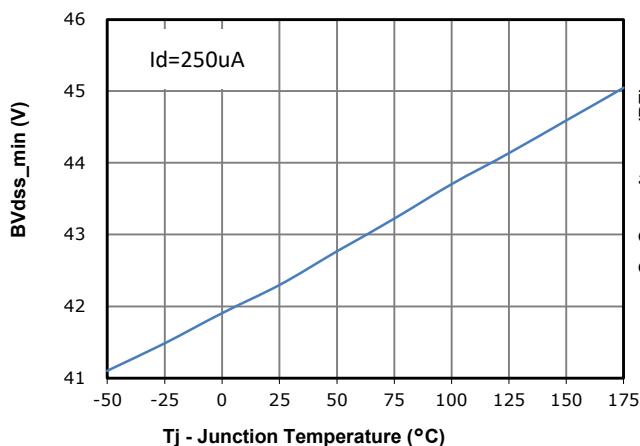


Fig 8: Capacitance Characteristics

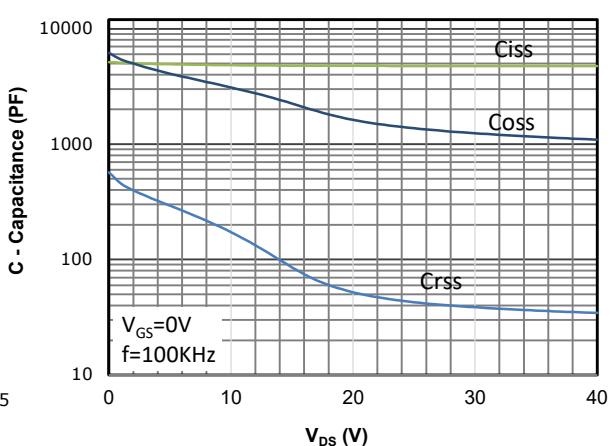


Fig 9: Gate Charge Characteristics

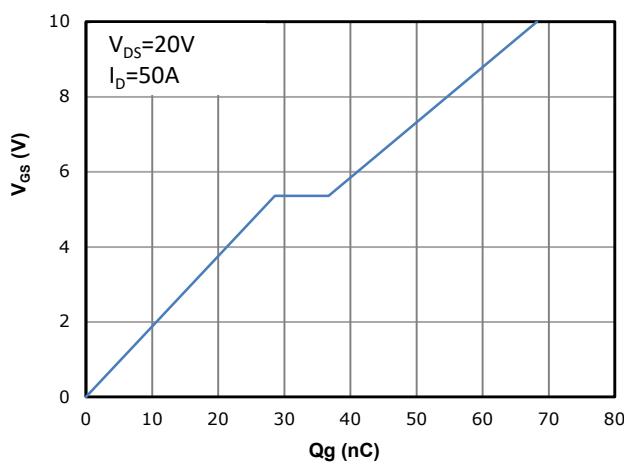


Fig 10: Body-diode Forward Characteristics

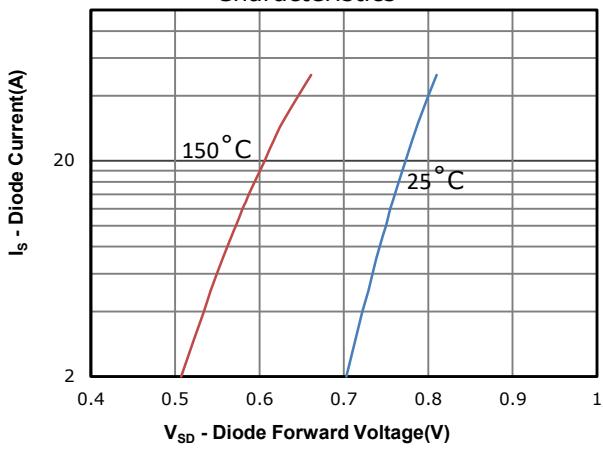


Fig 11: Power Dissipation

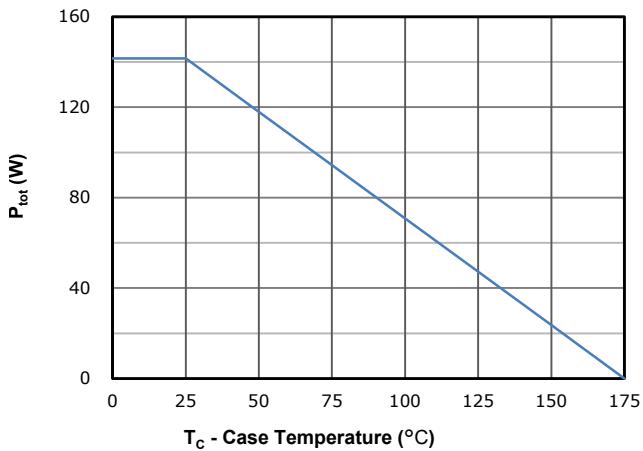


Fig 12: Drain Current Derating

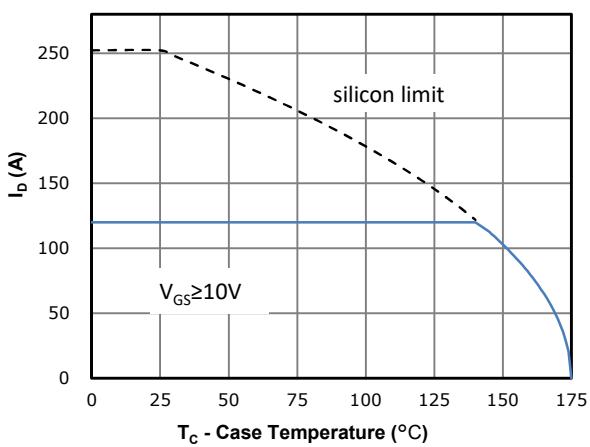


Fig 13: Safe Operating Area

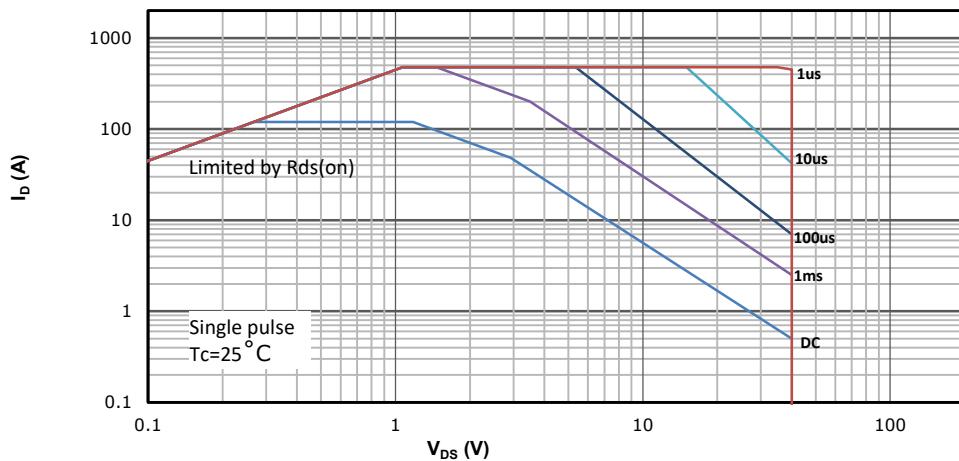
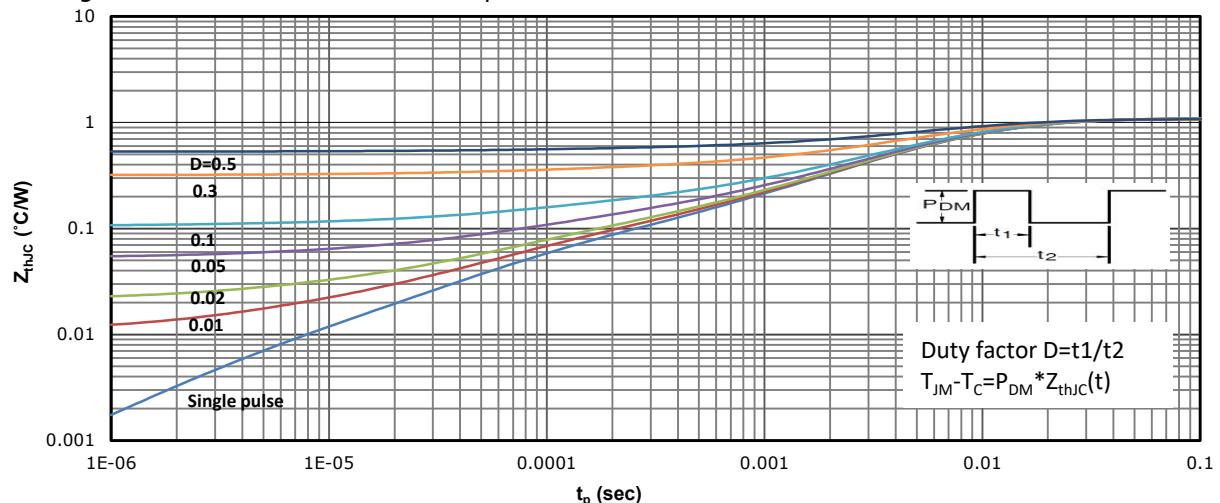
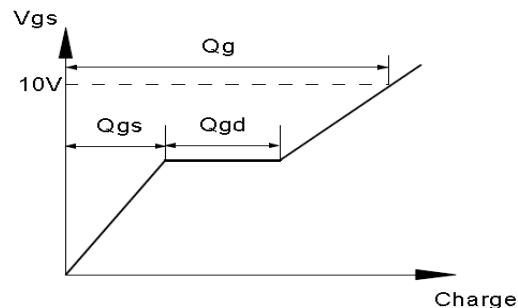
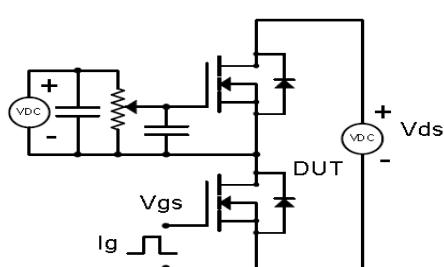


Fig 14: Max. Transient Thermal Impedance

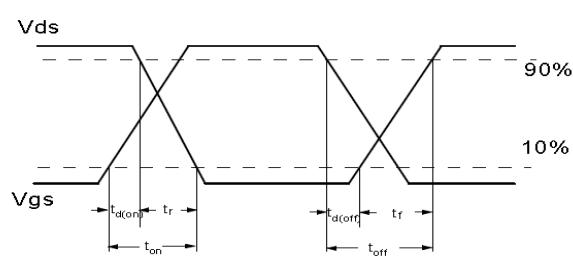
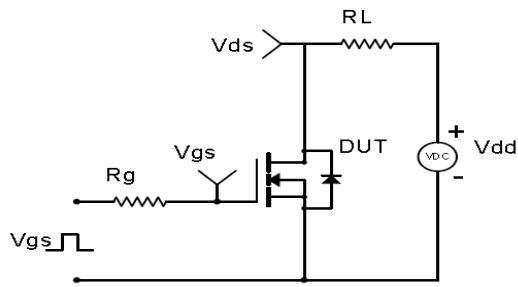


Test Circuit & Waveform

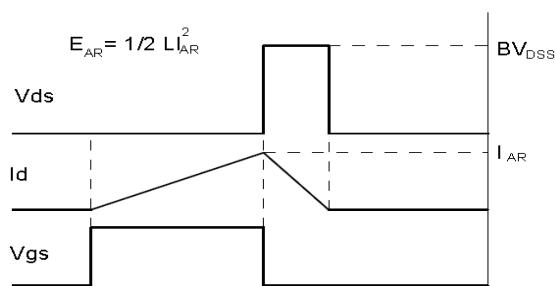
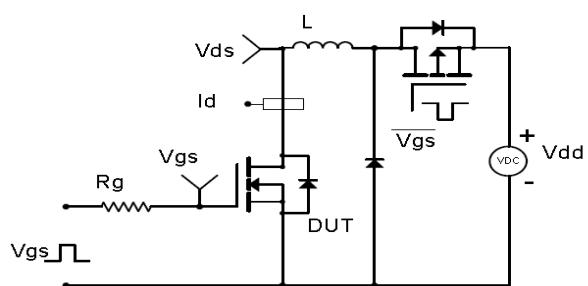
Gate Charge Test Circuit & Waveform



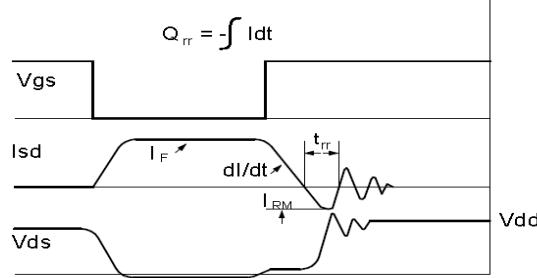
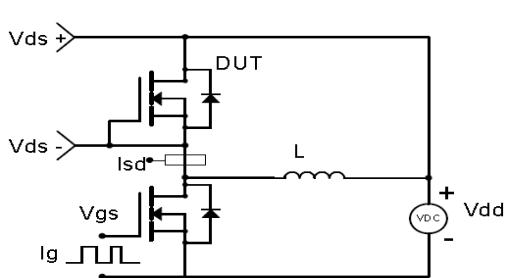
Resistive Switching Test Circuit & Waveforms

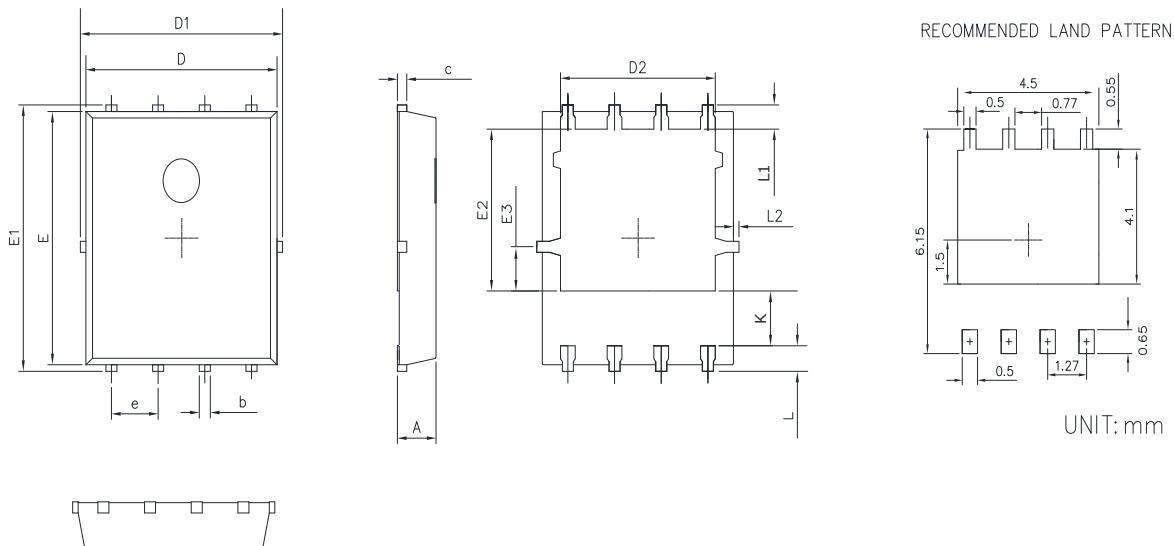


Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Package Outline: DFN5X6

SYMBOL	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.90	1.10	0.035	0.043
b	0.25	0.50	0.010	0.020
c	0.10	0.30	0.004	0.012
D	4.80	5.30	0.189	0.209
D1	4.90	5.50	0.193	0.217
D2	3.92	4.20	0.154	0.165
E	5.65	5.85	0.222	0.230
E1	5.90	6.20	0.232	0.244
E2	3.33	3.78	0.131	0.149
E3	0.80	1.00	0.031	0.039
e	1.27		0.050	
L	0.40	0.70	0.016	0.028
L1	0.65		0.026	
L2	0.00	0.15	0.000	0.006
K	1.00	1.50	0.039	0.059

Revision History

Revison	Date	Major changes
1.0	2023/3/19	Release of Formal Version.
1.1	2024/11/23	Updated the ID from 260A to 120A.
2.0	2025/2/28	Updated Rth,SOA,etc.
2.1	2025/8/11	Updated Ciss/Coss/Crss test condition to 250KHZ and value

Disclaimer

Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

Unless otherwise specified in the datasheet, the product is designed and qualified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

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